

NOT RECOMMENDED FOR NEW DESIGN -**NO ALTERNATE PART**



DMS3015SSS

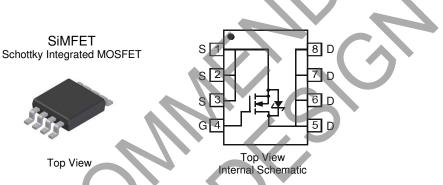
N-CHANNEL ENHANCEMENT MODE MOSFET WITH SCHOTTKY DIODE

Features

- High Density UMOS with Schottky Barrier Diode
- Low Leakage Current at High Temp.
- High Conversion Efficiency
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Utilizes Diodes Incorporated's Monolithic SiMFET Technology to Increase Conversion Efficiency
- 100% UIS and R_a Tested
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.072 grams (Approximate)



Ordering Information (Note 4)

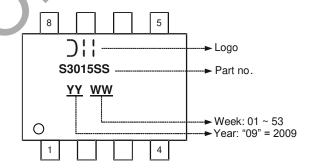
Part Number	Case	Packaging
DMS3015SSS-13	SO-8	2500 / Tape & Reel

Notes:

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- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





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Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characte	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	30	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5) V _{GS} = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +85^{\circ}C$	I _D	11 6.6	Α
Pulsed Drain Current (Note 6)	I _{DM}	80	Α		
Avalanche Current (Notes 6 & 7)			I _{AR}	17	Α
Repetitive Avalanche Energy (Notes 6 & 7) L = 0.3mH			E _{AR}	43	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	1.55	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 5)	$R_{ heta JA}$	81.3	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

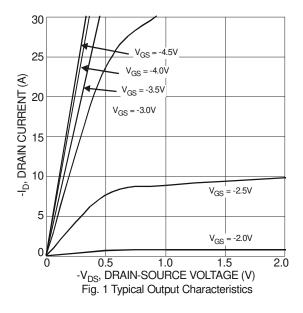
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	-		V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	IDSS	-	-	0.1	mA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	$V_{GS(TH)}$	1.0	1.5	2.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Pagan	-	8.5	11.9 14.9	mΩ	$V_{GS} = 10V, I_D = 11A$	
Static Dialif-Source Off-Nesistance	R _{DS(ON)}	-	9.5			$V_{GS} = 4.5V, I_D = 8.8A$	
Forward Transfer Admittance	Y _{fs}	-	18	-	S	$V_{DS} = 5V, I_{D} = 10A$	
Diode Forward Voltage	V_{SD}	-	0.45	1	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	-	1276	-	pF	V 45V V 0V	
Output Capacitance	Coss	-	160	-	pF	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	-	136	-	pF	1 = 1.000112	
Gate Resistance	R_g	-	1.48	2.7	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	-	14.3	-	nC	$V_{DS} = 15V, V_{GS} = 4.5V, I_{D} = 8.8A$	
Total Gate Charge (V _{GS} = 10V)	Qg	-	30.6	-	nC	151/1/ 101/1 0.04	
Gate-Source Charge	Q _{gs}	-	3.4	-	nC	$V_{DS} = 15V, V_{GS} = 10V, I_D = 8.8A$	
Gate-Drain Charge	Q_{gd}	-	4.3	-	nC		
Turn-On Delay Time	t _{D(ON)}	-	15.8	-	ns		
Turn-On Rise Time	t _R	-	27.8	-	ns	$V_{GS} = 4.5V, V_{DS} = 15V,$	
Turn-Off Delay Time	t _{D(OFF)}	-	29.7	-	ns	$R_G = 1.8\Omega, I_D = 8.8A$	
Turn-Off Fall Time	t _F	-	13.6	-	ns		

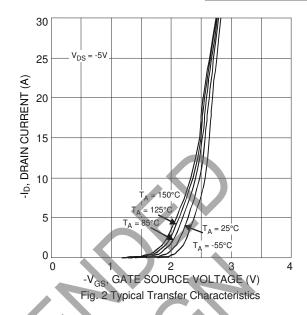
Notes:

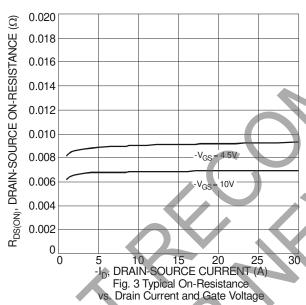
- 5. Device mounted on 1 in * 1 in FR-4 PCB with 2oz. Copper. The value in any given application depends on the user's specific board design. 6. Repetitive rating, pulse width limited by junction temperature.
- 7. I_{AR} and E_{AR} ratings are based on low frequency and duty cycles to keep $T_{J}=\pm25$ °C.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.

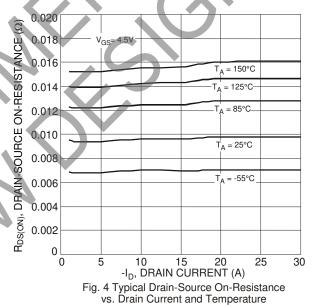
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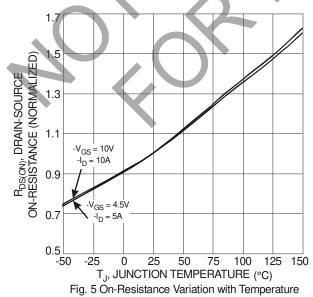
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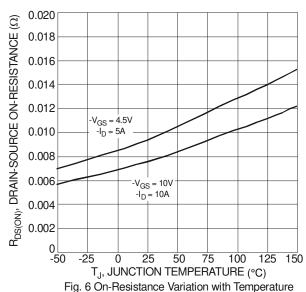












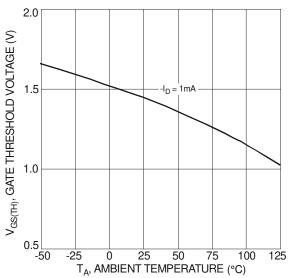
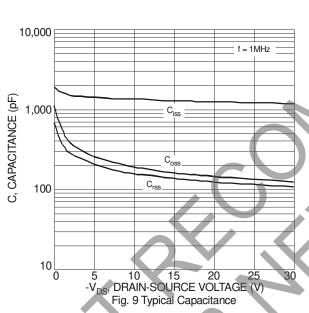
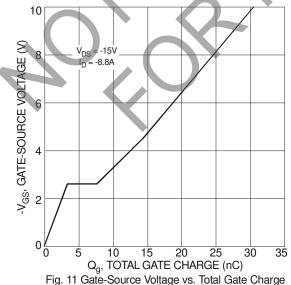


Fig. 7 Gate Threshold Variation vs. Ambient Temperature





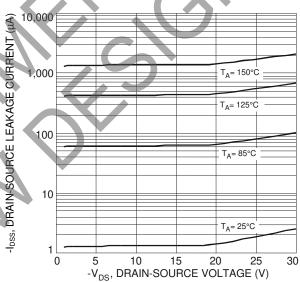
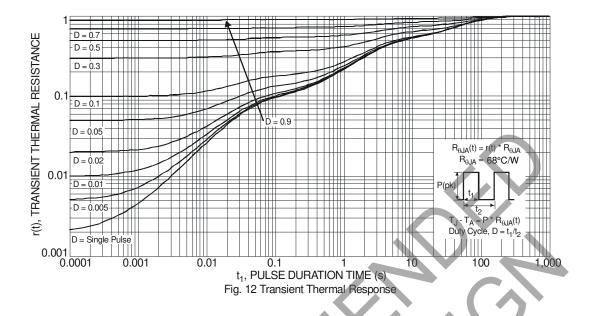


Fig. 10 Typical Drain-Source Leakage Current vs. Drain-Source Voltage

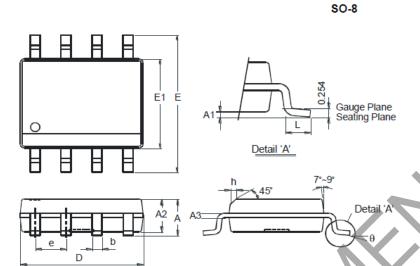




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Package Outline Dimensions

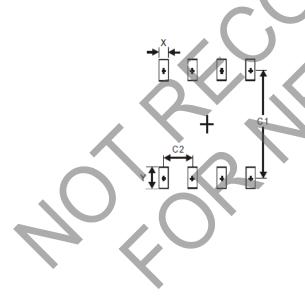
Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8				
Dim	Min	Max		
Α		1.75		
A1	0.10	0.20		
A2	1.30	1.50		
A3	0.15	0.25		
b	0.3	0.5		
D	4.85	4.95		
E	5.90	6.10		
E1	3.85	3.95		
e 1.27 Typ				
h	-	0.35		
L	0.62	0.82		
θ	0°	8°		
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
X	0.60
Y	1.55
C1	5.4
C2	1 27



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